

60V P-Channel Trench MOSFET(Preliminary)

General Description

- Trench Power technology
- Low R_{DS(ON)}
- Low Gate Charge
- Optimized for fast-switching applications

Applications

- Synchronous Rectification in DC/DC and AC/DC Converters
- Isolated DC/DC Converters in Telecom and Industrial

Product Summary

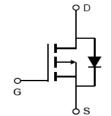
 $\begin{array}{ll} V_{DS} & -60V \\ I_{D} \ (at \ V_{GS} = -10V) & -80A \\ R_{DS(ON)} \ (at \ V_{GS} = -10V) & < 13m\Omega \end{array}$

 $R_{DS(ON)}$ (at V_{GS} =-4.5V) < 16m Ω

100% UIS Tested







| Part Number | Package Type | Form | Marking |
|-------------|--------------|------|---------|
| TTP80P06AT | TO-220 | Tube | 80P06AT |

Absolute Maximum Ratings (T_A =25°C unless otherwise noted)

| Parameter | | Maximum | Units |
|-----------------------------------------------------|----------------------------------------------------------------------------------------------|-------------------------------------------------------|-------------------------------------------------------|
| Drain-Source Voltage | | - 60 | V |
| Gate-Source Voltage | | ±20 | V |
| T _C =25°C | | -80 | ۸ |
| T _C =100°C | I _D | -52 | A |
| Pulsed Drain Current A | | -240 | Α |
| Avalanche Current ^ | | -80 | Α |
| Single Pulse Avalanche Energy L =0.3mH ^A | | 690 | mJ |
| T _C =25°C | - P _D | 145 | W |
| T _C =100°C | | 72 | W |
| Junction and Storage Temperature Range | | -55 to 175 | °C |
| | $T_{C} = 100^{\circ}C$ $L = 0.3 \text{mH}^{-A}$ $T_{C} = 25^{\circ}C$ $T_{C} = 100^{\circ}C$ | $\begin{array}{c ccccccccccccccccccccccccccccccccccc$ | $\begin{array}{c ccccccccccccccccccccccccccccccccccc$ |

Thermal Characteristics

| Parameter | | Symbol | Maximum | Units | |
|-----------------------------|--------------|-----------------|---------|-------|--|
| Maximum Junction-to-Case | Steady-State | $R_{\Theta JC}$ | 1.0 | °C/W | |
| Maximum Junction-to-Ambient | Steady-State | $R_{\Theta JA}$ | 100 | *C/VV | |



| | - | Conditions | | Value | | | |
|----------------------|-----------------------------------------|-------------------------------------------------------------------|-----------------------|-------|------|------|-------|
| Symbol | Parameter | | | Min | Тур | Max | Units |
| STATIC P | ARAMETERS | ' | | | | | |
| BV _{DSS} | Drain-Source Breakdown Voltage | I _D =-250μA,V _{GS} =0V | | -60 | | | V |
| | | V _{DS} =-60V, V _{GS} =0V | T _J =25°C | | | -1 | μA |
| I _{DSS} | Zero Gate Voltage Drain Current | | T _J =100°C | | | -100 | |
| I _{GSS} | Gate-Body Leakage Current | $V_{DS} = 0V, V_{GS} = \pm 20V$ | 1 | | | ±100 | nA |
| $V_{GS(th)}$ | Gate Threshold Voltage | V _{DS} =V _{GS} , I _D =-250μA | | -1 | -1.5 | -2.4 | V |
| 5 | 0.00 | V _{GS} =-10V, I _D =-20A | | | 11 | 13 | mΩ |
| $R_{DS(ON)}$ | Static Drain-Source On-Resistance | V _{GS} =-4.5V, I _D =-20A | | | 13 | 16 | mΩ |
| g _{FS} | Forward Transconductance | V _{DS} =-5V, I _D =-20A | | | 25 | | S |
| V_{SD} | Diode Forward Voltage | I _S =-20A, V _{GS} =0V | | | | -1 | V |
| Is | Maximum Body-Diode Continuous Current B | | | | -30 | Α | |
| DYNAMIC | PARAMETERS | | | | • | • | - |
| C _{iss} | Input Capacitance | V _{GS} =0V, V _{DS} =-30V, f =1MH _Z | | | 5700 | | pF |
| C _{oss} | Output Capacitance | | | | 1840 | | |
| C _{rss} | Reverse Transfer Capacitance | | | | 1550 | | |
| SWITCHI | NG PARAMETERS | | | | | | |
| Q _g (10V) | Total Gate Charge | V _{GS} =-10V,V _{DS} =-30V, I _D =-20A | | | 65.6 | | |
| Q_{gs} | Gate Source Charge | | | | 9.6 | | nC |
| Q_{gd} | Gate Drain Charge | | | | 17.2 | | |
| t _{D(on)} | Turn-On Delay Time | $V_{GS} = -10V, V_{DS} = -30V, I_{D} = -20A,$ $R_{G} = 3\Omega$ | | | 20 | | ns |
| t _r | Turn-On Rise Time | | | | 28 | | |
| $T_{D(off)}$ | Turn-Off Delay Time | | | | 48 | | |
| t _f | Turn-Off Fall Time | | | | 32 | | |
| t _{rr} | Body Diode Reverse Recovery Time | 1 - 20A di/dt 400A | /110 | | 52 | | ns |
| Q _{rr} | Body Diode Reverse Recovery Charge | I _F =-20A, di/dt =100A/μs | | | 75 | | nC |

- A. Single pulse width limited by maximum junction temperature.
- B. The maximum current rating is package limited.
- C. The power dissipation P_D is based on $T_{J(MAX)} = 175$ °C, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heatsinking is used.



Typical Characteristics $T_J = 25^{\circ}\text{C}$, unless otherwise noted

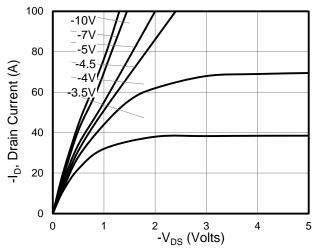


Figure 1: On-Region Characteristics

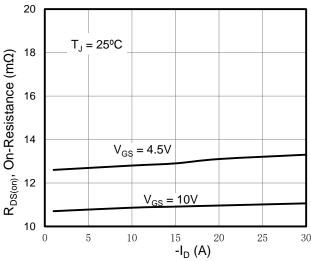


Figure 3: On-Resistance vs. Drain Current

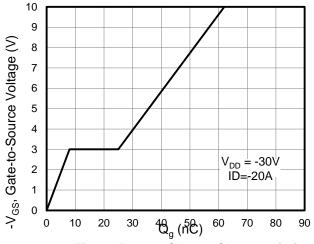


Figure 5: Gate Charge Characteristics

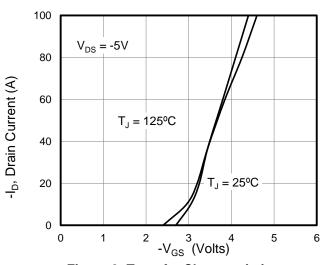


Figure 2: Transfer Characteristics

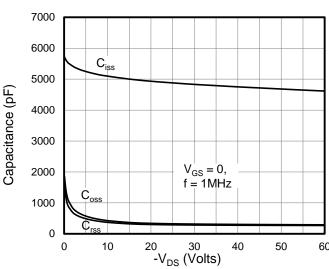


Figure 4: Capacitance Characteristics

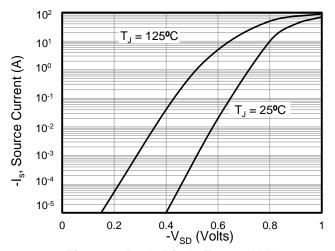
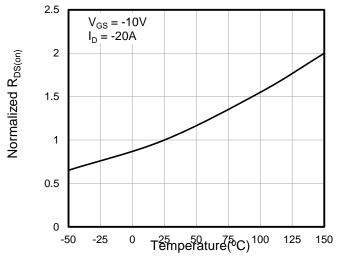


Figure 6: Body Diode Forward Voltage

 $Z_{\theta\, JC}$ Normalized Transient Thermal Resistance

Typical Characteristics $T_J = 25^{\circ}C$, unless otherwise noted



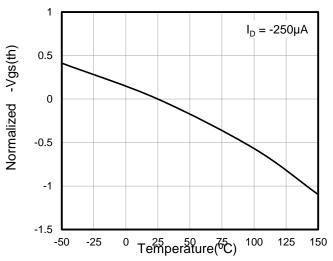
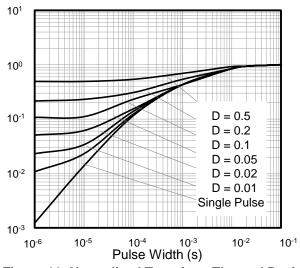


Figure 7: On-Resistance vs. Junction Temperature





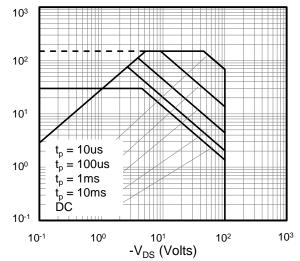


Figure 11: Normalized Transient Thermal Resistance

Figure 12: Safe Operating Area

-I_D (Amps)

Figure A: Gate Charge Test Circuit and Waveform

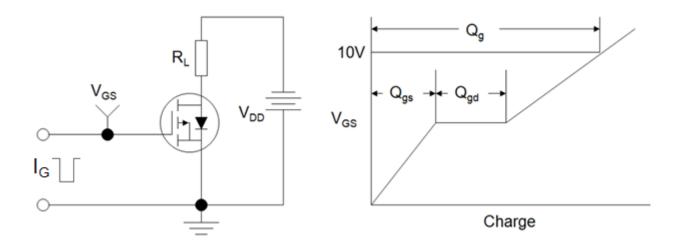


Figure B: Resistive Switching Test Circuit and Waveform

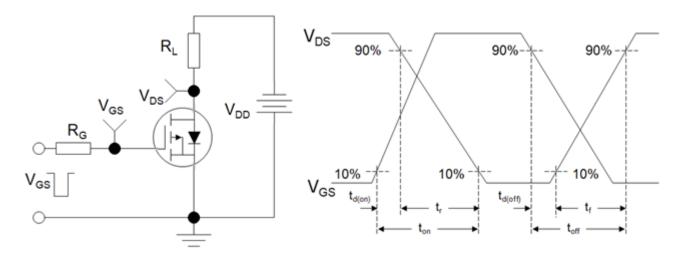
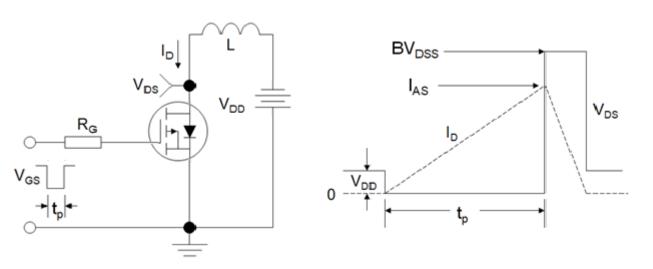
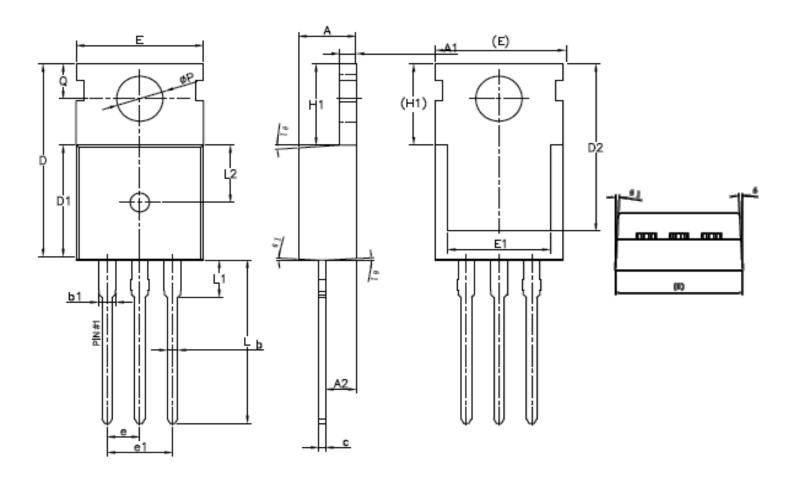


Figure C: Unclamped Inductive Switching Test Circuit and Waveform





TO-220 (I)



| SYMBOL | MIN | NOM | MAX | |
|--------|----------------|-------|-------|--|
| Α | 4.40 | 4.50 | 4.60 | |
| A1 | 1.27 | 1.30 | 1.33 | |
| A2 | 2.30 | 2.40 | 2.50 | |
| b | 0.70 | - | 0.90 | |
| b1 | 1.27 | - | 1.40 | |
| c | 0.45 | 0.50 | 0.60 | |
| D | 15.30 | 15.70 | 16.10 | |
| D1 | 9.10 | 9.20 | 9.30 | |
| D2 | 13.10 | 1 | 13.70 | |
| Е | 9.70 | 9.90 | 10.20 | |
| E1 | 7.80 | 8.00 | 8.20 | |
| е | 2.54BSC | | | |
| e1 | 5.08BSC | | | |
| H1 | 6.30 | 6.50 | 6.70 | |
| L | 12.78 | 13.08 | 13.38 | |
| L1 | | | 3.50 | |
| L2 | 4.60REF | | | |
| øΡ | 3.55 3.60 3.65 | | | |
| Q | 2.73 | _ | 2.87 | |
| 0 1 | 1" | 3' | 5* | |



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